

# AOD472 Datasheet

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|                              |   |
|------------------------------|---|
| DiGi Electronics Part Number | AOD472-DG   |
| Manufacturer                 | <a href="#">Alpha &amp; Omega Semiconductor Inc.</a>                    |
| Manufacturer Product Number  | AOD472  |
| Description                  | MOSFET N-CH 25V 55A TO252   |
| Detailed Description         | N-Channel 25 V 55A (Tc) 2.5W (Ta), 60W (Tc) Surface Mount TO-252 (DPAK) |

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## Purchase and inquiry

|   |   |
|---|---|
| Manufacturer Product Number:            | Manufacturer:                           |
| AOD472                                  | Alpha & Omega Semiconductor Inc.        |
| Series:                                 | Product Status:                         |
| -                                       | Obsolete                                |
| FET Type:                               | Technology:                             |
| N-Channel                               | MOSFET (Metal Oxide)                    |
| Drain to Source Voltage (Vdss):         | Current - Continuous Drain (Id) @ 25°C: |
| 25 V                                    | 55A (Tc)                                |
| Drive Voltage (Max Rds On, Min Rds On): | Rds On (Max) @ Id, Vgs:                 |
| 4.5V, 10V                               | 6mOhm @ 30A, 10V                        |
| Vgs(th) (Max) @ Id:                     | Gate Charge (Qg) (Max) @ Vgs:           |
| 2.5V @ 250µA                            | 50 nC @ 10 V                            |
| Vgs (Max):                              | Input Capacitance (Ciss) (Max) @ Vds:   |
| ±20V                                    | 2460 pF @ 12.5 V                        |
| FET Feature:                            | Power Dissipation (Max):                |
| -                                       | 2.5W (Ta), 60W (Tc)                     |
| Operating Temperature:                  | Mounting Type:                          |
| -55°C ~ 175°C (Tj)                      | Surface Mount                           |
| Supplier Device Package:                | Package / Case:                         |
| TO-252 (DPAK)                           | TO-252-3, DPAK (2 Leads + Tab), SC-63   |
| Base Product Number:                    |   |
| AOD47                                   |   |

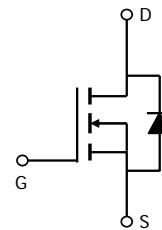
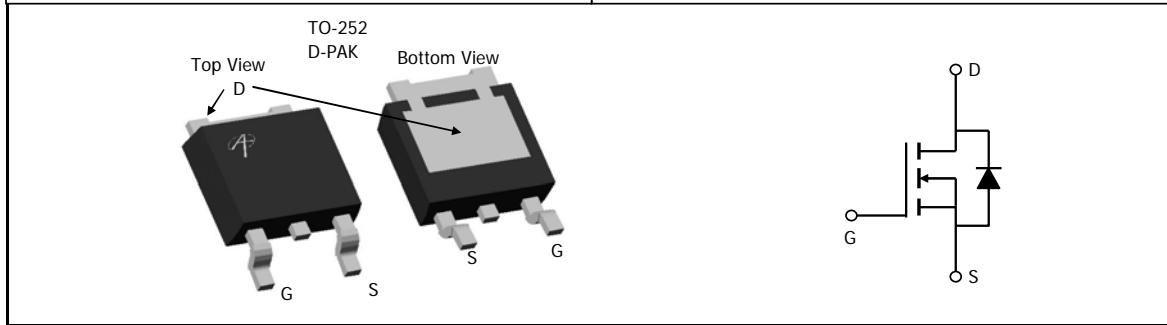
## Environmental & Export classification

|                                   |                  |
|-----------------------------------|------------------|
| Moisture Sensitivity Level (MSL): | REACH Status:    |
| 1 (Unlimited)                     | REACH Unaffected |
| ECCN:                             | HTSUS:           |
| EAR99                             | 8541.29.0095     |



## AOD472 N-Channel Enhancement Mode Field Effect Transistor

| General Description  | Features  |
|--|---|
| The AOD472 uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. This device is suitable for use in PWM, load switching and general purpose applications. | $V_{DS} (V) = 25V$<br>$I_D = 55A (V_{GS} = 10V)$<br>$R_{DS(ON)} < 6 m\Omega (V_{GS} = 10V)$<br>$R_{DS(ON)} < 9.5 m\Omega (V_{GS} = 4.5V)$<br><br>100% UIS Tested<br>100% $R_g$ Tested |



| Absolute Maximum Ratings $T_A=25^\circ C$ unless otherwise noted |                |            |            |  |
|--|----------------|------------|------------|--|
| Parameter  | Symbol         | Maximum    | Units      |  |
| Drain-Source Voltage   | $V_{DS}$       | 25         | V          |  |
| Gate-Source Voltage  | $V_{GS}$       | $\pm 20$   | V          |  |
| Continuous Drain Current <sup>G</sup>                            | $I_D$          | 55         | A          |  |
| $T_C=100^\circ C$  |                | 43         |            |  |
| Pulsed Drain Current <sup>C</sup>                                | $I_{DM}$       | 200        |            |  |
| Pulsed Forward Diode Current <sup>C</sup>                        | $I_{SM}$       | 200        |            |  |
| Avalanche Current <sup>C</sup>                                   | $I_{AR}$       | 50         |            |  |
| Repetitive avalanche energy $L=0.1mH$ <sup>C</sup>               | $E_{AR}$       | 125        |            |  |
| Power Dissipation <sup>B</sup>                                   | $P_D$          | 60         | W          |  |
| $T_C=100^\circ C$  |                | 30         |            |  |
| Power Dissipation <sup>A</sup>                                   | $P_{DSM}$      | 2.5        | W          |  |
| $T_A=70^\circ C$   |                | 1.6        |            |  |
| Junction and Storage Temperature Range                           | $T_J, T_{STG}$ | -55 to 175 | $^\circ C$ |  |

| Thermal Characteristics                  |              |                 |     |              |
|--|--------------|-----------------|-----|--------------|
| Parameter                                | Symbol       | Typ             | Max | Units        |
| Maximum Junction-to-Ambient <sup>A</sup> | $t \leq 10s$ | $R_{\theta JA}$ | 15  | $^\circ C/W$ |
| Maximum Junction-to-Ambient <sup>A</sup> | Steady-State |                 | 41  | $^\circ C/W$ |
| Maximum Junction-to-Case <sup>B</sup>    | Steady-State | $R_{\theta JC}$ | 2.1 | $^\circ C/W$ |

## AOD472

Electrical Characteristics ( $T_J=25^\circ\text{C}$  unless otherwise noted)

| Symbol                      | Parameter                             | Conditions   | Min  | Typ  | Max | Units            |
|-----------------------------|---------------------------------------|--|------|------|-----|------------------|
| <b>STATIC PARAMETERS</b>    |                                       |  |      |      |     |                  |
| $\text{BV}_{\text{DSS}}$    | Drain-Source Breakdown Voltage        | $I_D=250\mu\text{A}, V_{GS}=0\text{V}$   | 25   |      |     | V                |
| $I_{DSS}$                   | Zero Gate Voltage Drain Current       | $V_{DS}=20\text{V}, V_{GS}=0\text{V}$<br>$T_J=55^\circ\text{C}$                  |      | 1    | 5   | $\mu\text{A}$    |
| $I_{GSS}$                   | Gate-Body leakage current             | $V_{DS}=0\text{V}, V_{GS}=\pm20\text{V}$   |      | 100  |     | nA               |
| $V_{GS(\text{th})}$         | Gate Threshold Voltage                | $V_{DS}=V_{GS}, I_D=250\mu\text{A}$  | 1.2  | 1.4  | 2.5 | V                |
| $I_{D(\text{ON})}$          | On state drain current                | $V_{GS}=10\text{V}, V_{DS}=5\text{V}$  | 150  |      |     | A                |
| $R_{DS(\text{ON})}$         | Static Drain-Source On-Resistance     | $V_{GS}=10\text{V}, I_D=30\text{A}$<br>$T_J=125^\circ\text{C}$                   | 5    | 6    |     | $\text{m}\Omega$ |
|                             |                                       | $V_{GS}=4.5\text{V}, I_D=20\text{A}$   | 7.6  | 9.5  |     |                  |
| $g_{FS}$                    | Forward Transconductance              | $V_{DS}=5\text{V}, I_D=20\text{A}$   | 49   |      |     | S                |
| $V_{SD}$                    | Diode Forward Voltage                 | $I_S=1\text{A}, V_{GS}=0\text{V}$  | 0.74 | 1    |     | V                |
| $I_S$                       | Maximum Body-Diode Continuous Current |  |      | 50   |     | A                |
| <b>DYNAMIC PARAMETERS</b>   |                                       |  |      |      |     |                  |
| $C_{iss}$                   | Input Capacitance                     | $V_{GS}=0\text{V}, V_{DS}=12.5\text{V}, f=1\text{MHz}$                           | 2050 | 2460 |     | pF               |
| $C_{oss}$                   | Output Capacitance                    |  | 485  | 600  |     | pF               |
| $C_{rss}$                   | Reverse Transfer Capacitance          |  | 280  | 400  |     | pF               |
| $R_g$                       | Gate resistance                       | $V_{GS}=0\text{V}, V_{DS}=0\text{V}, f=1\text{MHz}$                              | 0.86 | 1.5  |     | $\Omega$         |
| <b>SWITCHING PARAMETERS</b> |                                       |  |      |      |     |                  |
| $Q_g(10\text{V})$           | Total Gate Charge                     | $V_{GS}=10\text{V}, V_{DS}=12.5\text{V}, I_D=20\text{A}$                         | 41   | 50   |     | nC               |
| $Q_g(4.5\text{V})$          | Total Gate Charge                     |  | 20   | 25   |     | nC               |
| $Q_{gs}$                    | Gate Source Charge                    |  | 7.3  | 8.8  |     | nC               |
| $Q_{gsVth}$                 | Gate Source Charge at $V_{th}$        |  | 3.4  | 4    |     | nC               |
| $Q_{gd}$                    | Gate Drain Charge                     |  | 8.2  | 11.5 |     | nC               |
| $t_{D(\text{on})}$          | Turn-On DelayTime                     | $V_{GS}=10\text{V}, V_{DS}=12.5\text{V}, R_L=0.68\Omega, R_{\text{GEN}}=3\Omega$ | 7.5  | 10   |     | ns               |
| $t_r$                       | Turn-On Rise Time                     |  | 11   | 22   |     | ns               |
| $t_{D(\text{off})}$         | Turn-Off DelayTime                    |  | 27   | 35   |     | ns               |
| $t_f$                       | Turn-Off Fall Time                    |  | 8    | 16   |     | ns               |
| $t_{rr}$                    | Body Diode Reverse Recovery Time      | $I_F=20\text{A}, dI/dt=100\text{A}/\mu\text{s}$                                  | 30   | 36   |     | ns               |
| $Q_{rr}$                    | Body Diode Reverse Recovery Charge    | $I_F=20\text{A}, dI/dt=100\text{A}/\mu\text{s}$                                  | 19   | 23   |     | nC               |

A: The value of  $R_{\text{DSM}}$  is measured with the device mounted on 1 in  $^2$  FR-4 board with 2oz. Copper, in a still air environment with  $T_A=25^\circ\text{C}$ . The Power dissipation  $P_{\text{DSM}}$  is based on  $R_{\text{DSM}}$  and the maximum allowed junction temperature of  $150^\circ\text{C}$ . The value in any given application depends on the user's specific board design, and the maximum temperature of  $175^\circ\text{C}$  may be used if the PCB allows it.

B: The power dissipation  $P_D$  is based on  $T_{J(\text{MAX})}=175^\circ\text{C}$ , using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.

C: Repetitive rating, pulse width limited by junction temperature  $T_{J(\text{MAX})}=175^\circ\text{C}$ .

D. The  $R_{\text{DSM}}$  is the sum of the thermal impedance from junction to case  $R_{\text{JJC}}$  and case to ambient.

E. The static characteristics in Figures 1 to 6 are obtained using  $<300\ \mu\text{s}$  pulses, duty cycle 0.5% max.

F. These curves are based on the junction-to-case thermal impedance which is measured with the device mounted to a large heatsink, assuming a maximum junction temperature of  $T_{J(\text{MAX})}=175^\circ\text{C}$ .

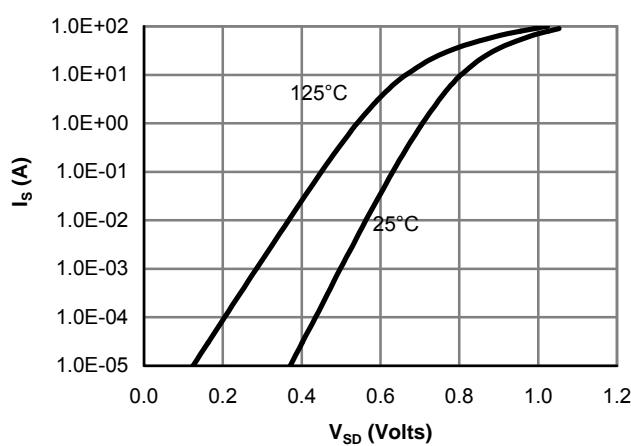
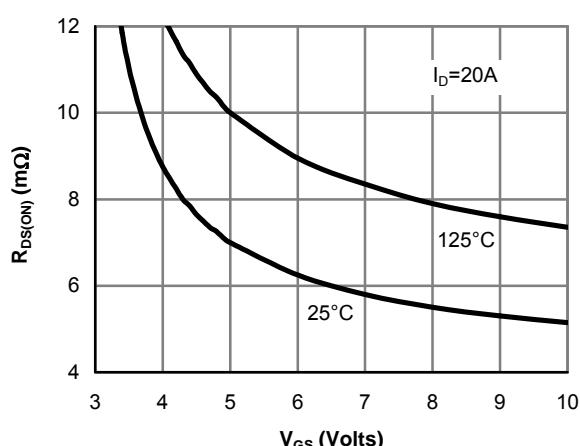
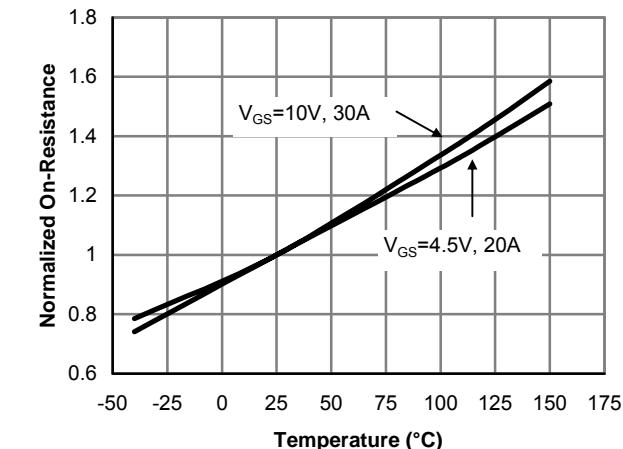
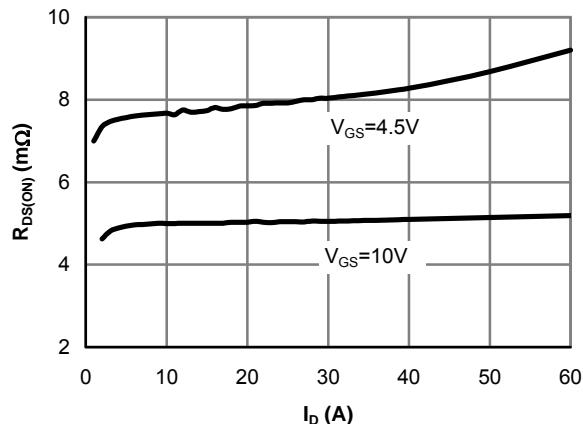
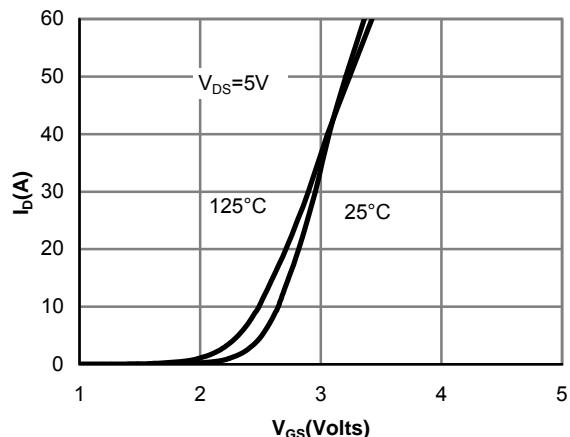
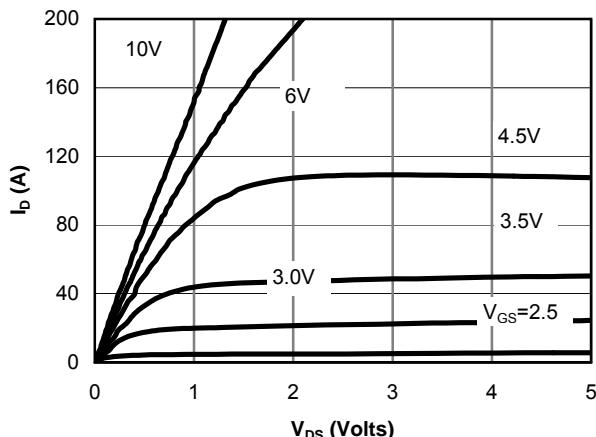
G. The maximum current rating is limited by bond-wires.

H. These tests are performed with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with  $T_A=25^\circ\text{C}$ . The SOA curve provides a single pulse rating.

\*This device is guaranteed green after data code 8X11 (Sep 1<sup>ST</sup> 2008).

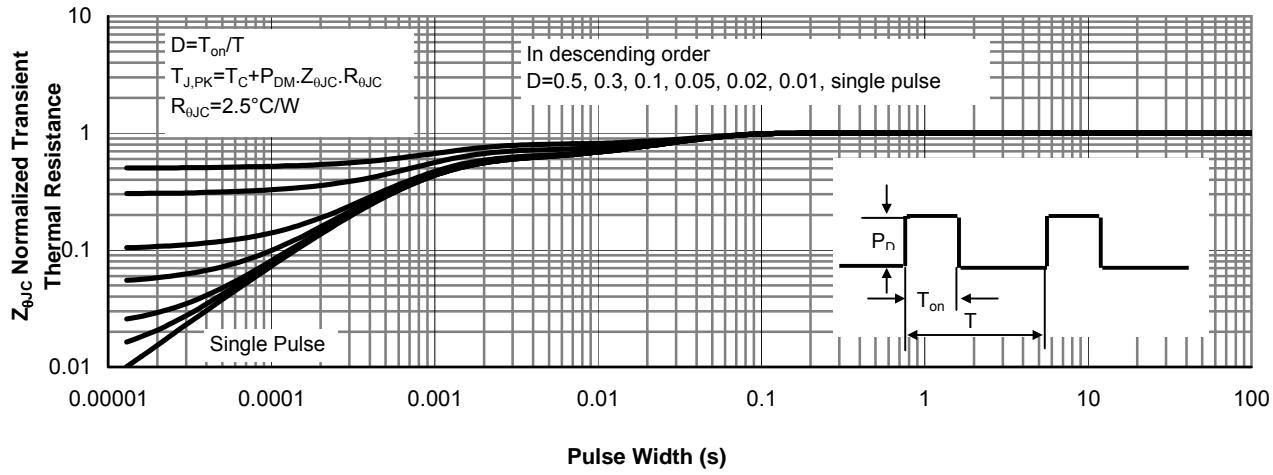
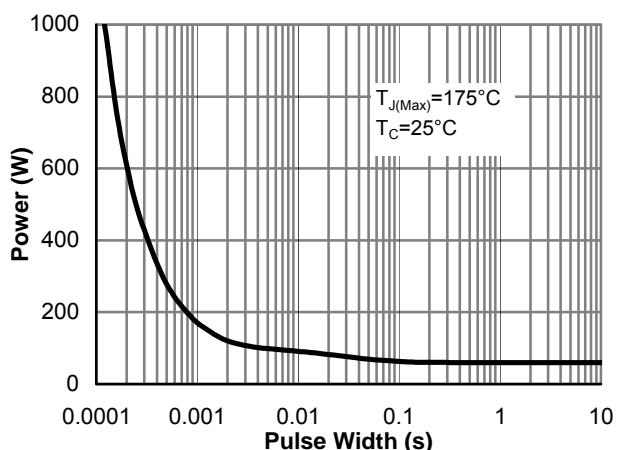
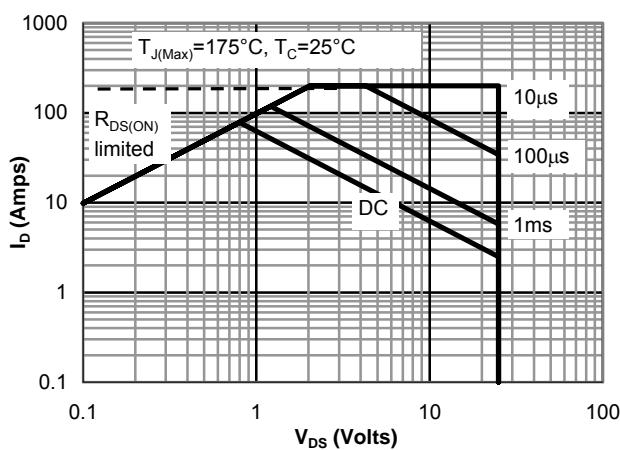
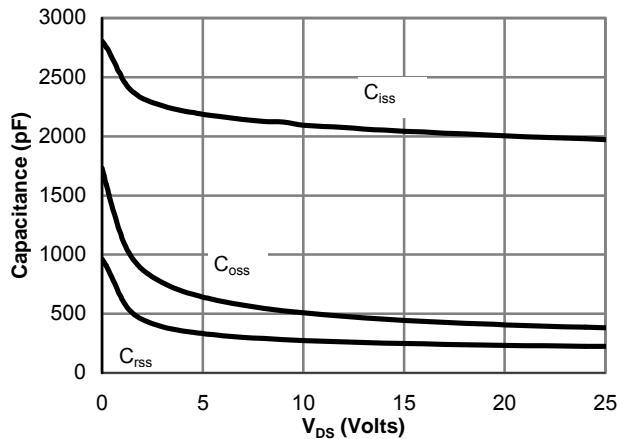
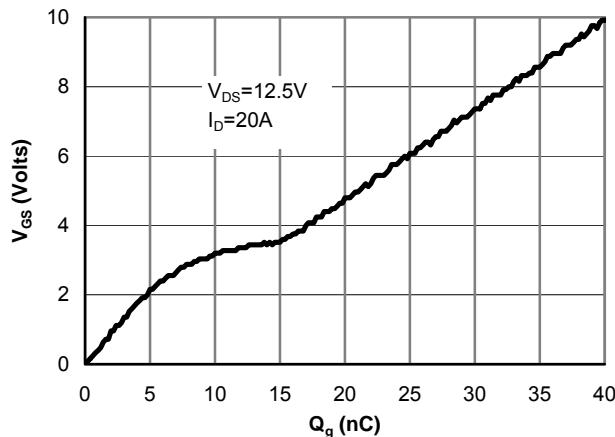
Rev9: Feb 2010

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**AOD472****TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS**

## AOD472

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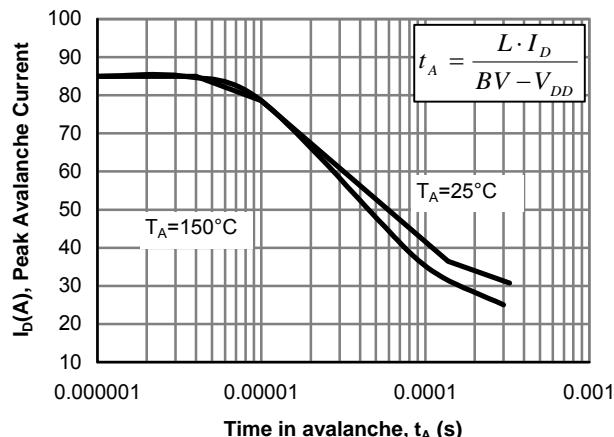


Figure 12: Single Pulse Avalanche capability

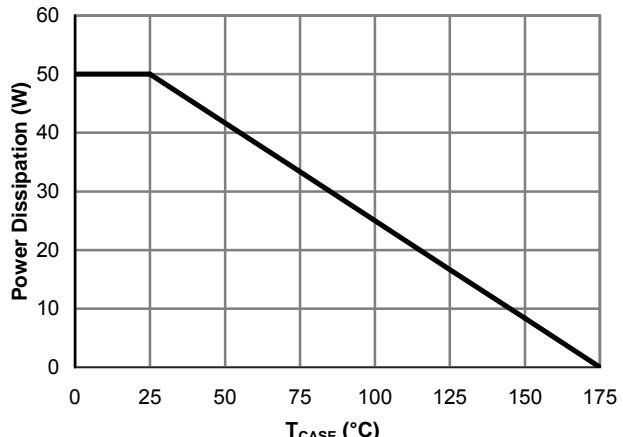


Figure 13: Power De-rating (Note B)

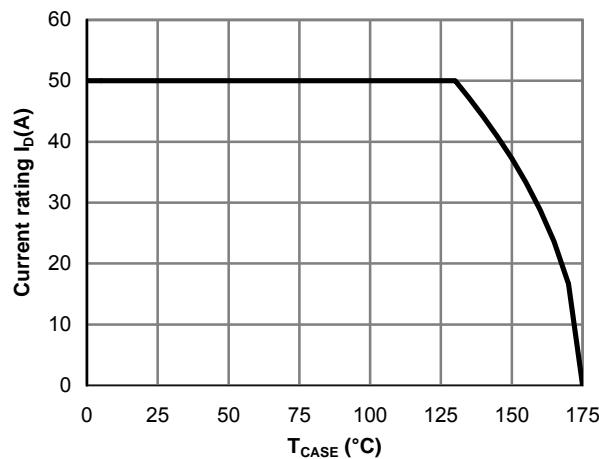


Figure 14: Current De-rating (Note B)

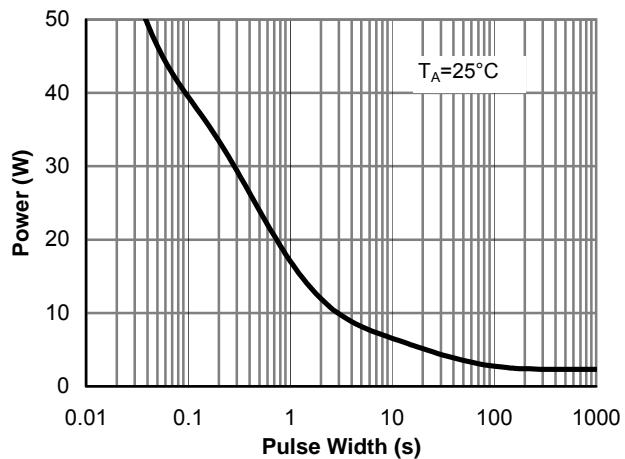


Figure 15: Single Pulse Power Rating Junction-to-Ambient (Note H)

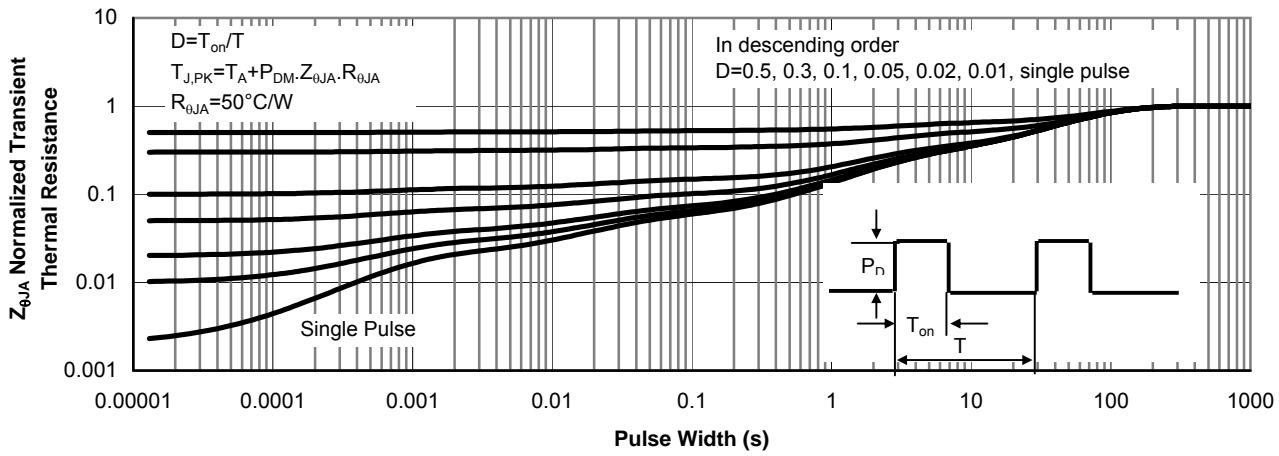
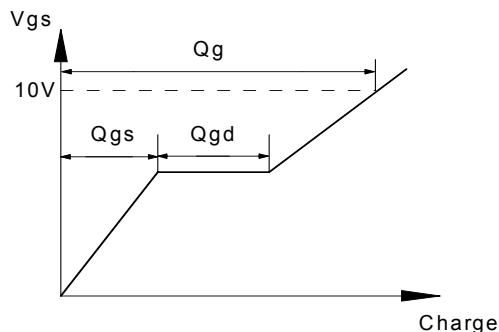
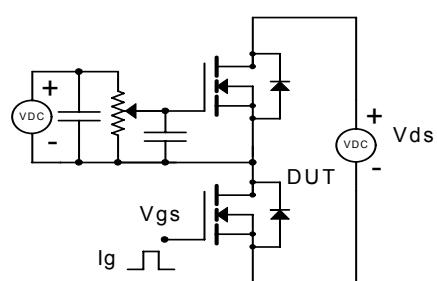
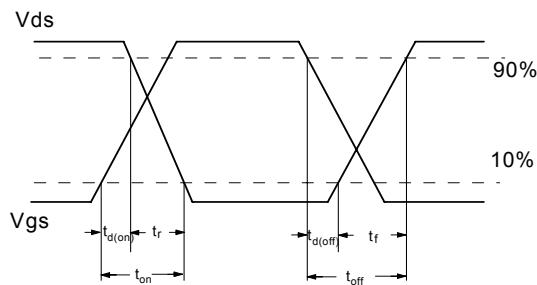
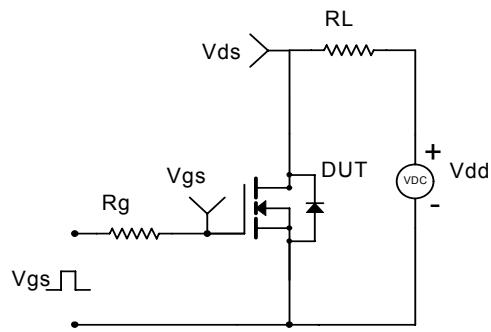
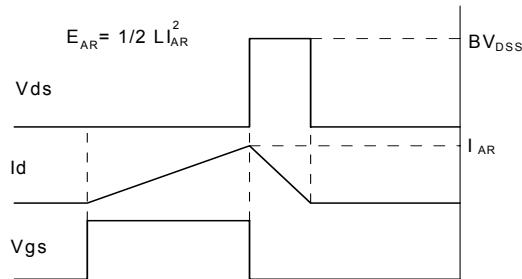
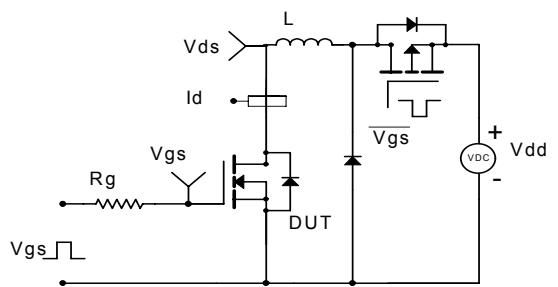
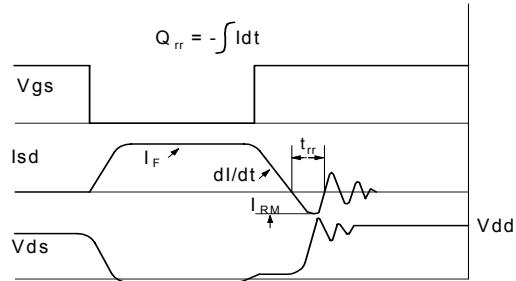
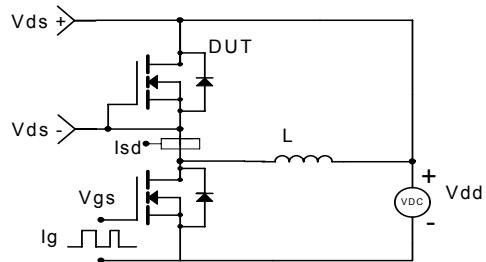


Figure 16: Normalized Maximum Transient Thermal Impedance (Note H)

**AOD472****Gate Charge Test Circuit & Waveform****Resistive Switching Test Circuit & Waveforms****Unclamped Inductive Switching (UIS) Test Circuit & Waveforms****Diode Recovery Test Circuit & Waveforms**

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